



Description

The IRFR3709ZTRPBF uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

$V_{DS} = 30V$ $I_D = 80A$

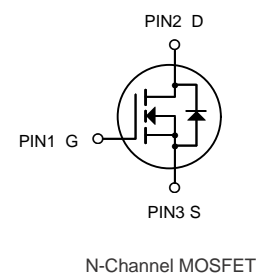
$R_{DS(ON)} < 6.8m\Omega$ @ $V_{GS}=10V$

Application

Battery protection

Load switch

Uninterruptible power supply



Package Marking and Ordering Information

| Product ID | Pack | Marking | Qty(PCS) |
|----------------|---------------------------|--------------|----------|
| IRFR3709ZTRPBF | TO-252-2L(TO-252-2(DPAK)) | RFR3709 XXXX | 2500 |

Absolute Maximum Ratings ($T_C=25^{\circ}C$ unless otherwise noted)

| Symbol | Parameter | Rating | Units |
|-----------------|---|------------|----------------|
| V_{DS} | Drain-Source Voltage | 30 | V |
| V_{GS} | Gate-Source Voltage | ± 20 | V |
| I_D | Drain Current – Continuous ($T_C=25^{\circ}C$) | 80 | A |
| | Drain Current – Continuous ($T_C=100^{\circ}C$) | 51 | A |
| I_{DM} | Drain Current – Pulsed ¹ | 320 | A |
| EAS | Single Pulse Avalanche Energy ² | 88 | mJ |
| IAS | Single Pulse Avalanche Current ² | 42 | A |
| P_D | Power Dissipation ($T_C=25^{\circ}C$) | 54 | W |
| | Power Dissipation – Derate above $25^{\circ}C$ | 0.43 | W/ $^{\circ}C$ |
| T_{STG} | Storage Temperature Range | -55 to 150 | $^{\circ}C$ |
| T_J | Operating Junction Temperature Range | -55 to 150 | $^{\circ}C$ |
| $R_{\theta JA}$ | Thermal Resistance Junction to ambient | 62 | $^{\circ}C/W$ |
| $R_{\theta JC}$ | Thermal Resistance Junction to Case | 2.3 | $^{\circ}C/W$ |



Electrical Characteristics ($T_J=25^{\circ}\text{C}$, unless otherwise noted)

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|---------------------------|--|--|------|------|-----------|-----------------------|
| BVDSS | Drain-Source Breakdown Voltage | $V_{GS}=0V$, $I_D=250\mu A$ | 30 | --- | --- | V |
| $\Delta BVDSS/\Delta T_J$ | BV_{DSS} Temperature Coefficient | Reference to 25°C , $I_D=1mA$ | --- | 0.04 | --- | $V/^{\circ}\text{C}$ |
| IDSS | Drain-Source Leakage Current | $V_{DS}=30V$, $V_{GS}=0V$, $T_J=25^{\circ}\text{C}$ | --- | --- | 1 | μA |
| | | $V_{DS}=24V$, $V_{GS}=0V$, $T_J=125^{\circ}\text{C}$ | --- | --- | 10 | μA |
| IGSS | Gate-Source Leakage Current | $V_{GS}=\pm 20V$, $V_{DS}=0V$ | --- | --- | ± 100 | nA |
| RDS(ON) | Static Drain-Source On-Resistance ³ | $V_{GS}=10V$, $I_D=20A$ | --- | 5 | 6.8 | $m\Omega$ |
| | | $V_{GS}=4.5V$, $I_D=10A$ | --- | 6.5 | 9 | $m\Omega$ |
| VGS(th) | Gate Threshold Voltage | $V_{GS}=V_{DS}$, $I_D=250\mu A$ | 1 | 1.6 | 2.5 | V |
| $\Delta V_{GS(th)}$ | $V_{GS(th)}$ Temperature Coefficient | | --- | -4 | --- | $mV/^{\circ}\text{C}$ |
| gfs | Forward Transconductance | $V_{DS}=10V$, $I_D=10A$ | --- | 18 | --- | S |
| Q_g | Total Gate Charge ^{3, 4} | $V_{DS}=15V$, $V_{GS}=4.5V$, $I_D=20A$ | --- | 11.1 | --- | nC |
| Q_{gs} | Gate-Source Charge ^{3, 4} | | --- | 1.85 | --- | |
| Q_{gd} | Gate-Drain Charge ^{3, 4} | | --- | 6.8 | --- | |
| $T_{d(on)}$ | Turn-On Delay Time ^{3, 4} | $V_{DD}=15V$, $V_{GS}=10V$, $R_G=3.3\Omega$ $I_D=15A$ | --- | 7.5 | --- | ns |
| T_r | Rise Time ^{3, 4} | | --- | 14.5 | --- | |
| $T_{d(off)}$ | Turn-Off Delay Time ^{3, 4} | | --- | 35.2 | --- | |
| T_f | Fall Time ^{3, 4} | | --- | 9.6 | --- | |
| Ciss | Input Capacitance | $V_{DS}=25V$, $V_{GS}=0V$, $F=1MHz$ | --- | 1160 | --- | pF |
| Coss | Output Capacitance | $V_{GS}=0V$, $V_{DS}=0V$, $F=1MHz$ | --- | 200 | --- | Ω |
| Crss | Reverse Transfer Capacitance | | --- | 180 | --- | |
| R_g | Gate resistance | | --- | 2.5 | --- | |
| EAS | Single Pulse Avalanche Energy | $V_{DD}=25V$, $L=0.1mH$, $I_{AS}=20A$ | 20 | --- | --- | mJ |
| IS | Continuous Source Current | $V_G=V_D=0V$, Force Current | --- | --- | 80 | A |
| ISM | Pulsed Source Current ³ | | --- | --- | 320 | A |
| VSD | Diode Forward Voltage ³ | $V_{GS}=0V$, $I_S=1A$, $T_J=25^{\circ}\text{C}$ | --- | --- | 1 | V |
| trr | Reverse Recovery Time | $V_{GS}=0V$, $I_S=1A$, $di/dt=100A/\mu s$, $T_J=25^{\circ}\text{C}$ | --- | --- | --- | ns |
| Q_{rr} | Reverse Recovery Charge | | --- | --- | --- | nC |



Typical Characteristics

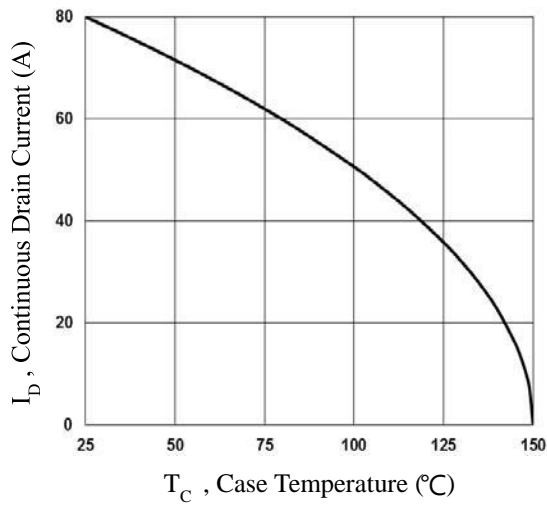


Fig.1 Continuous Drain Current vs. T_C

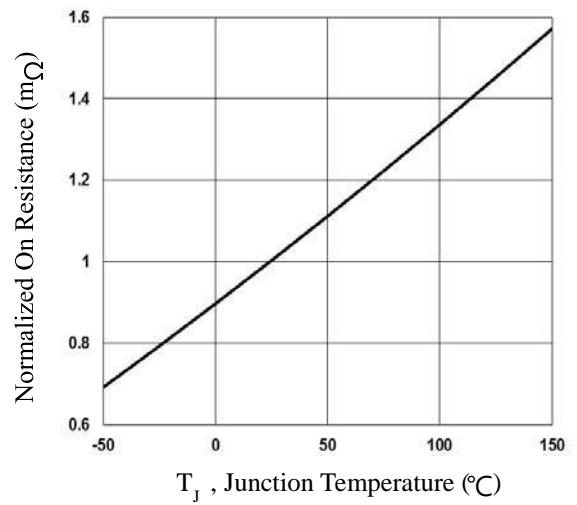


Fig.2 Normalized $R_{DS(on)}$ vs. T_J

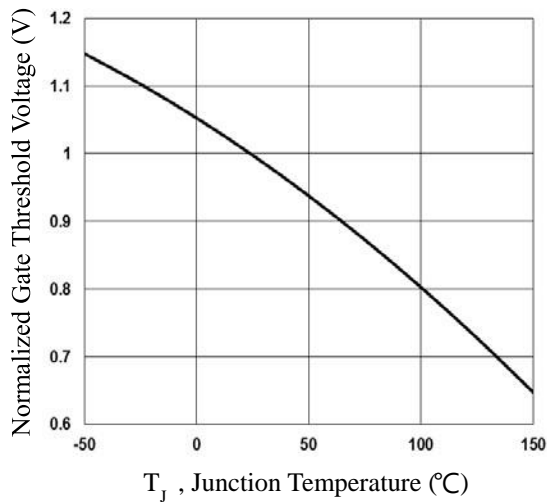


Fig.3 Normalized V_{th} vs. T_J

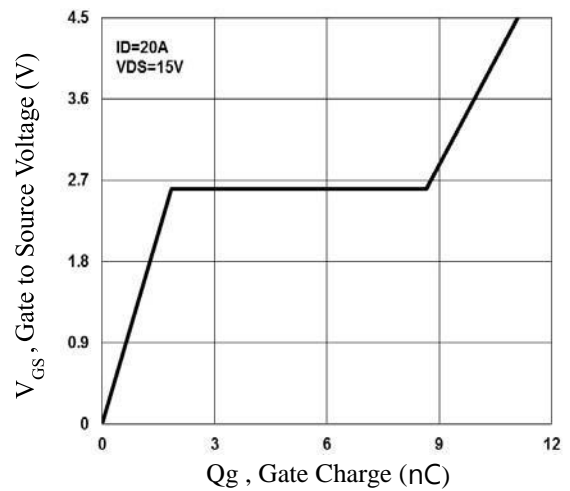


Fig.4 Gate Charge Waveform

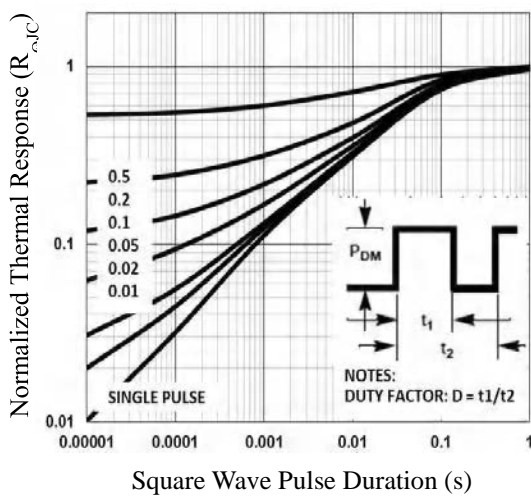


Fig.5 Normalized Transient Impedance

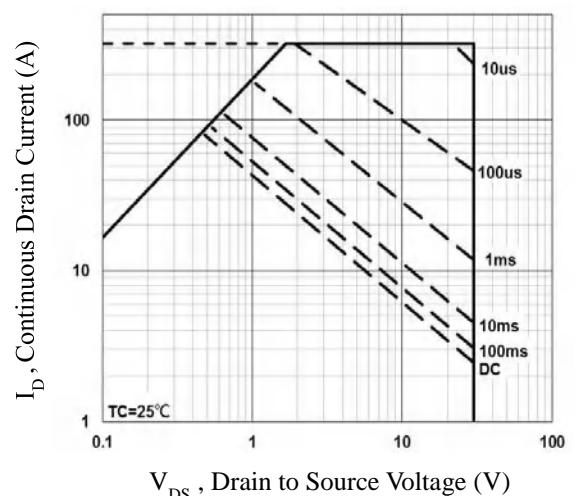


Fig.6 Maximum Safe Operation Area

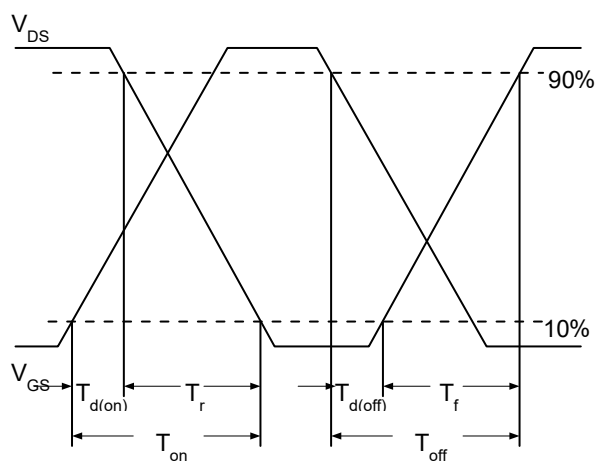


Fig.7 Switching Time Waveform

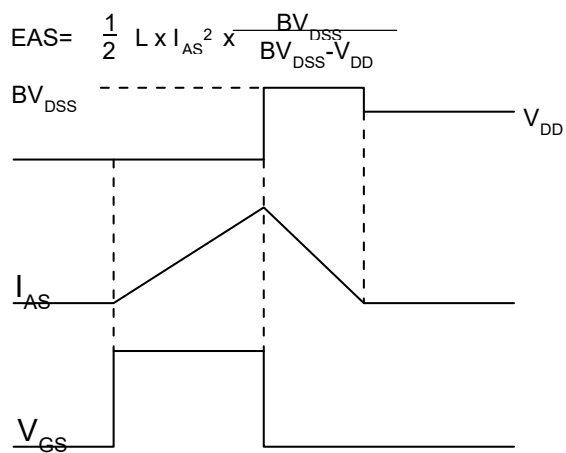


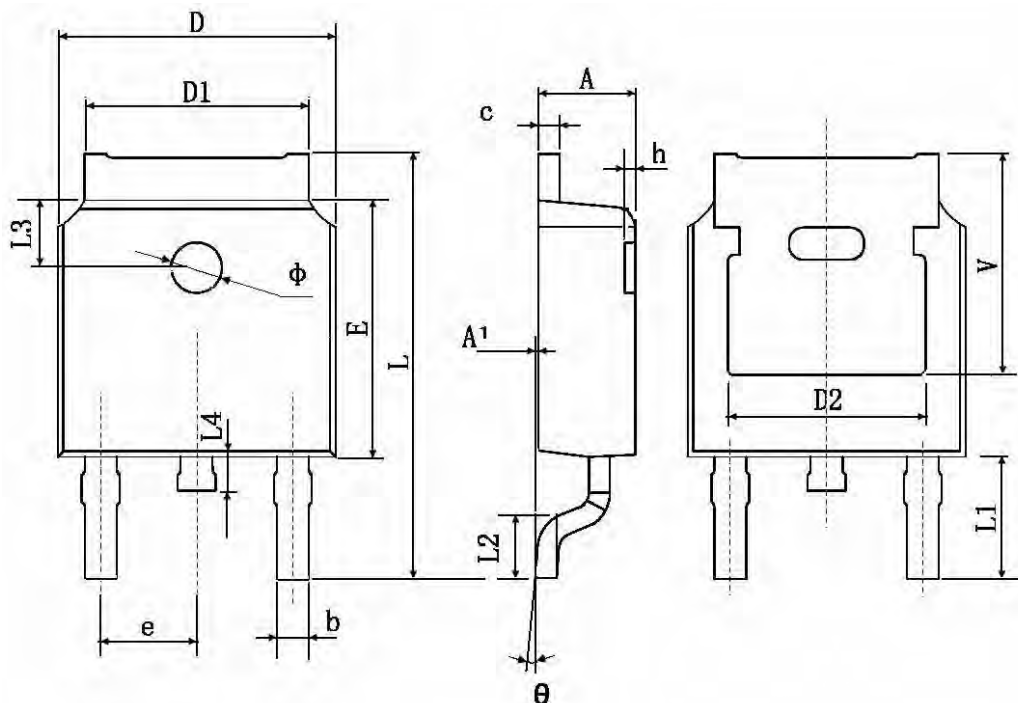
Fig.8 EAS Waveform



IRFR3709ZTRPBF

N-Channel Enhancement Mode MOSFET

TO-252-2L(TO-252-2(DPAK)) Package Information



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|--------|----------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 2.200 | 2.400 | 0.087 | 0.094 |
| A1 | 0.000 | 0.127 | 0.000 | 0.005 |
| b | 0.660 | 0.860 | 0.026 | 0.034 |
| c | 0.460 | 0.580 | 0.018 | 0.023 |
| D | 6.500 | 6.700 | 0.256 | 0.264 |
| D1 | 5.100 | 5.460 | 0.201 | 0.215 |
| D2 | 0.483 TYP. | | 0.190 TYP. | |
| E | 6.000 | 6.200 | 0.236 | 0.244 |
| e | 2.186 | 2.386 | 0.086 | 0.094 |
| L | 9.800 | 10.400 | 0.386 | 0.409 |
| L1 | 2.900 TYP. | | 0.114 TYP. | |
| L2 | 1.400 | 1.700 | 0.055 | 0.067 |
| L3 | 1.600 TYP. | | 0.063 TYP. | |
| L4 | 0.600 | 1.000 | 0.024 | 0.039 |
| Φ | 1.100 | 1.300 | 0.043 | 0.051 |
| θ | 0° | 8° | 0° | 8° |
| h | 0.000 | 0.300 | 0.000 | 0.012 |
| V | 5.350 TYP. | | 0.211 TYP. | |



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